

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | |
|--|---|---------------|----------------|---------------------|------------|------------------|------------|---------------------|------------|------------------------|------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Dennis Tak Kit TONG</td> <td>03/29/2013</td> </tr> <tr> <td>Vincent Wai HUNG</td> <td>03/29/2013</td> </tr> <tr> <td>Danny Chih Hsun LIN</td> <td>03/28/2013</td> </tr> <tr> <td>Francis Guillen GAMBOA</td> <td>03/29/2013</td> </tr> </tbody> </table> | | Name | Execution Date | Dennis Tak Kit TONG | 03/29/2013 | Vincent Wai HUNG | 03/29/2013 | Danny Chih Hsun LIN | 03/28/2013 | Francis Guillen GAMBOA | 03/29/2013 |
| Name | Execution Date | | | | | | | | | | |
| Dennis Tak Kit TONG | 03/29/2013 | | | | | | | | | | |
| Vincent Wai HUNG | 03/29/2013 | | | | | | | | | | |
| Danny Chih Hsun LIN | 03/28/2013 | | | | | | | | | | |
| Francis Guillen GAMBOA | 03/29/2013 | | | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | | | |
| Name: | SAE Magnetics (H.K.) Ltd. | | | | | | | | | | |
| Street Address: | SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T. | | | | | | | | | | |
| City: | Hong Kong | | | | | | | | | | |
| State/Country: | HONG KONG | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13860531</td> </tr> </tbody> </table> | | Property Type | Number | Application Number: | 13860531 | | | | | | |
| Property Type | Number | | | | | | | | | | |
| Application Number: | 13860531 | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | |
| Fax Number: | | | | | | | | | | | |
| <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> | | | | | | | | | | | |
| Email: | charles_ho@barron-young.com | | | | | | | | | | |
| Correspondent Name: | B.Y.I.P., LTD | | | | | | | | | | |
| Address Line 1: | P.O. Box 1484, General Post Office | | | | | | | | | | |
| Address Line 4: | Hong Kong, HONG KONG | | | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | SAE-1304-USPT | | | | | | | | | | |
| NAME OF SUBMITTER: | Charles S. Ho | | | | | | | | | | |
| Signature: | /charles ho/ | | | | | | | | | | |
| Date: | 04/13/2013 | | | | | | | | | | |

OP \$40.00 13860531

Total Attachments: 4

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ASSIGNMENT - Patent Application

Docket Number: **SAE-1304-USPT**

Whereas, the Assignor, comprising the following named inventors:

ASSIGNOR(s)/
INVENTOR(s)

TONG, Dennis Tak Kit

made an invention entitled: **OPTOELECTRONIC PACKAGE AND METHOD FOR MAKING SAME**

for which an application for Letters Patent of the United States:

(Select one of the following):

- is executed concurrently herewith
 was filed in the U.S. Patent and Trademark Office on _____,
as U.S. Patent Application Serial No.: _____

ASSIGNEE
(Full Name, Address and
Country)

SAE Magnetics (H.K.) Ltd.

**SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science
Park, Shatin, N.T.**

Hong Kong

is desirous of acquiring our entire right, title and interest in and to said invention and the Letters Patent to be obtained therefor,

Now, therefore, in consideration of the payment by Assignee to Assignor of a sum corresponding to One Dollar (\$1.00), and for other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor, intending to be legally bound, hereby sells, assigns and transfers to Assignee, its successors and assigns, the full and exclusive right, title and interest in and to said invention, all applications for Letters Patent for said invention, including all divisions, continuations, and continuations-in-part thereof, all rights to claim priority based thereon, and all Letters Patent, including reissues, to be obtained therefor, including any and all foreign patent rights in this invention corresponding thereto.

Assignor hereby warrants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor agrees it shall be legally bound, upon request of the Assignee or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the Assignor has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the Assignee, and to execute all instruments proper to carry out the intent of this instrument.

In witness whereof, this Assignment is executed on the day indicated below.

| | Typed or Printed Name | Signature | Date |
|-----------|-----------------------------|-----------------------|-------------|
| SIGNATURE | TONG, Dennis Tak Kit | X | X 3/29/2013 |
| | TONG, KA LAP | X | X 3/29/2013 |
| | * Witness to Assignor | * Witness to Assignor | |

ASSIGNMENT - Patent Application

Docket Number: **SAE-1304-USPT**

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HUNG, Vincent Wai

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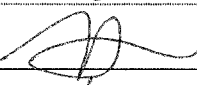
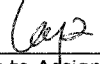
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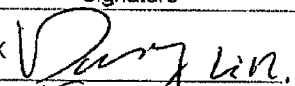

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| | Typed or Printed Name | Signature | Date |
|-----------|--------------------------|---|---------------|
| SIGNATURE | HUNG, Vincent Wai | X  | X 29-Mar-2013 |
| | TONG, KA LAP | X  | X 29-Mar-2013 |
| | * Witness to Assignor | * Witness to Assignor | |

| | | |
|--|--|-------------------------------------|
| ASSIGNMENT - Patent Application | | Docket Number: SAE-1304-USPT |
| Whereas, the Assignor, comprising the following named inventors: | | |
| ASSIGNOR(s)/ INVENTOR(s) | LIN, Danny Chih Hsun | |
| made an invention entitled: OPTOELECTRONIC PACKAGE AND METHOD FOR MAKING SAME | | |
| for which an application for Letters Patent of the United States: (Select one of the following): | | |
| <input checked="" type="checkbox"/> is executed concurrently herewith <input type="checkbox"/> was filed in the U.S. Patent and Trademark Office on _____, as U.S. Patent Application Serial No.: _____ | | |
| ASSIGNEE (Full Name, Address and Country) | SAE Magnetics (H.K.) Ltd. SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T. Hong Kong | |
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|-----------|--------------------------------------|--|-------------|
| SIGNATURE | LIN, Danny Chih Hsun | x  | x 3/28/2013 |
| | Karter Fok | x  | x 3/28/2013 |
| | <small>* Witness to Assignor</small> | <small>* Witness to Assignor</small> | |

ASSIGNMENT - Patent Application

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| SIGNATURE | GAMBOA, Francis Guillen | X  | x 29 March 2013 |
| | BAÑAL, MARGARITO JR. P. | X  | x 29 March 2013 |
| | * Witness to Assignor | * Witness to Assignor | |